



Product Change Notification

Change Notification #: 116033 - 00
Change Title: Intel® XWAY™ DELICVIP PEB20571 Chipset, PCN 116033-00, Product Discontinuance, End of Life
Date of Publication: January 18, 2018

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	July 31, 2018
Orders are Non-Cancelable and Non-Returnable After:	July 31, 2018
Last Product Discontinuance Shipment Date:	January 31, 2019

Description of Change to the Customer:

Intel® XWAY™ DELICVIP PEB20571 Chipset MM#946919 will End of Life.

Customer Impact of Change and Recommended Action:

Customers should place their Last Time Orders by July 31, 2018 and delivery of all orders must be no later than January 31, 2019.

Please use the recommended replacement sku as shows on the Products Affected/Intel Ordering Codes table below:

- Intel® XWAY™ DELICVIP Chipset , PEF20571 MM#946920
- The device with the extended temperature range is drop in compatible and has the same functionality as the standard version.

Milestone dates are estimates and subject to change based on business and operations conditions.

Please contact your local Intel Field Sales Representative if you have and further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® XWAY™ DELICVIP PEB20571 Chipset	PEB20571F	946919	PEF20571F	946920

PCN Revision History:

Date of Revision: January 18, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apagccb@intel.com

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